



Geneva 17th - 21st September 2017

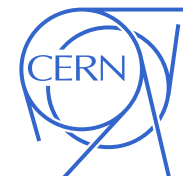
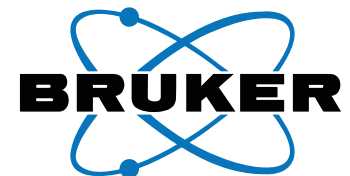
13th European Conference on Applied Superconductivity

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Magnetic Field Lab, FSU

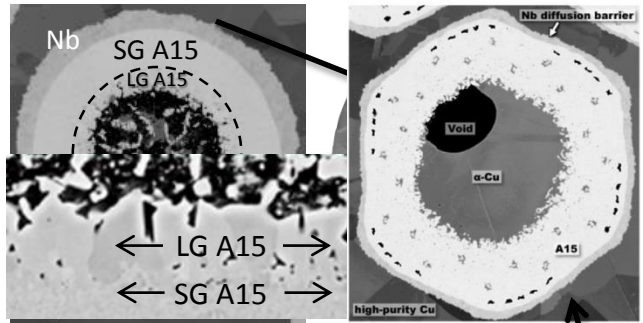
How Nb(Ta) tube leakage induced by inhomogeneous deformation robs a huge potential from Nb₃Sn PIT conductors

Many thanks to Bernd Sailer¹, Manfred Thoener¹, Klaus Schlenga¹ (Bruker¹) and Bernardo Bordini² and Amalia Ballarino² (CERN²) for discussions

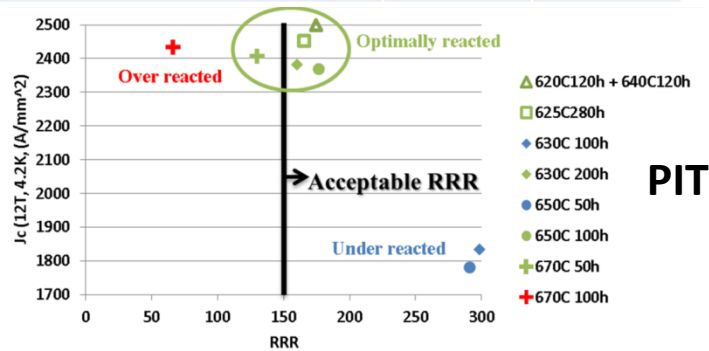


Introduction

Limitations in state of the art Nb₃Sn[1,2]



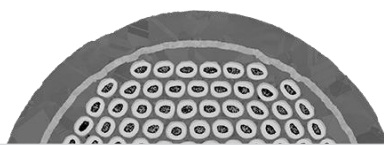
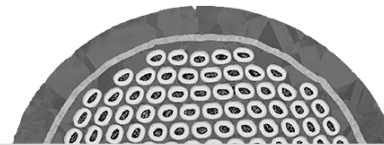
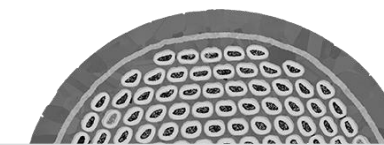
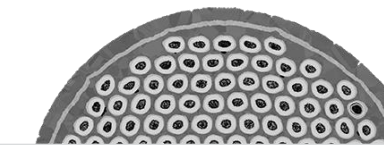
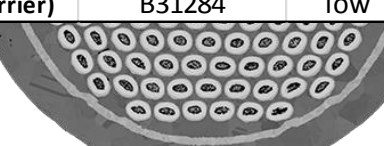

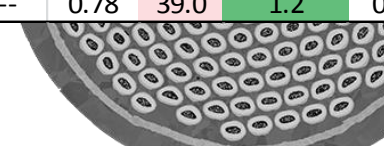

	PIT [1]	RRP[2]
J_c (12T, 4.2K)(A/mm ²)	2500	~2900
RRR	175	>150
Total A15 area fraction	58%	~60%
SG/LG ratio	2.9	--



[1] C. Tarantini *et al.*, "Composition and connectivity variability of the A15 phase in PIT Nb₃Sn wires," *SUST* 2015.

[2] Sanabria PhD Thesis 2017 ASC-NHMFL-FSU

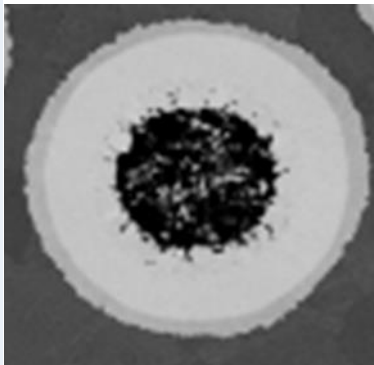
A large variety of architectures and properties

Medium Sn												High Sn			Very High Sn						
Luca				Bernardo				Bernardo 2				Lucio			Bernd						
																					
0.7 mm																					
Sample name	Sample ID	Sn	filaments	Jc(12T) A/mm2	Jc (15T) A/mm2	SG layer Jc (12T)	RRR	wire d (mm)	fil d (um)	Cu:non- Cu	bundle DB	Total A15	SG/LG A15	% SG A15	% LG A15	% Core A15	%Nb	% Cu	% Void	K-void	
Luca	P2693	med	156	2658	1508	6515	190	0.71	36.0	1.2	5.6%	59.2%	2.55	40.8%	16.0%	2.4%	21.0%	5.1%	14.7%	0.03%	
Bernardo	P2658	med	192	2561	1462	6308	132	0.71	33.3	1.1	5.4%	58.6%	2.59	40.6%	15.7%	2.3%	21.7%	5.3%	14.4%	0.13%	
Bernardo II	P2743	med	192	2455	1389	5859	141	0.72	34.7	0.97	6.0%	60.5%	2.64	41.9%	15.9%	2.7%	21.5%	4.6%	13.5%	0.27%	
Lucio	P2689	high	192	2434	1363	6257	168	0.72	35.0	0.99	5.0%	58.1%	2.30	38.9%	16.9%	2.3%	20.9%	6.4%	14.6%	0.36%	
Bernd	P2499	very high	192	2310	1315	5474	61	0.71	36.3	0.87	3.6%	59.0%	2.78	42.2%	15.2%	1.6%	19.9%	6.9%	14.2%	0.34%	
0.85mm																					
Luca	P2686	med	156	2640	1488	7021	112	0.86	44.0	1.19	5.6%	56.4%	2.28	37.6%	16.5%	2.3%	22.6%	7.0%	14.1%	0.04%	
Bernardo**	P2656	med	192	2599	1481	6370	127	0.87	40.5	1.12	5.4%	59.3%	2.63	40.8%	15.5%	3.0%	21.9%	5.4%	13.4%	0.10%	
Bernardo II	*P2736/P2774	med	192	2473	1400	6136	131	0.87	42.1	0.98	5.9%	58.8%	2.53	40.3%	15.9%	2.6%	23.0%	4.9%	13.3%	0.09%	
Lucio	P2683	high	192	2458	1390	6145	109	0.87	42.2	0.99	5.0%	59.6%	2.37	40.0%	16.9%	2.7%	20.9%	5.3%	14.3%	0.21%	
std (no bundle barrier)	B31284	low	192	2237	1259	5564	--	0.78	39.0	1.2	0.0%	56.0%	3.02	40.2%	13.3%	2.5%	23.4%			0.00%	
																					

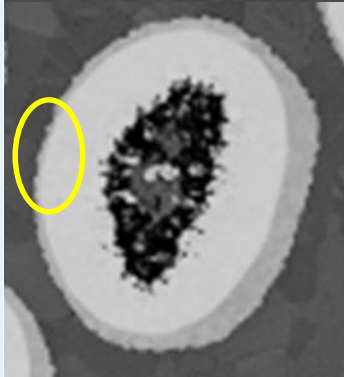
All higher J_c! BUT, why doesn't J_c increase with Sn content? We suspect Sn leaks

Leaked filaments lose Sn and SG A15 volume suffers

3 types of filaments



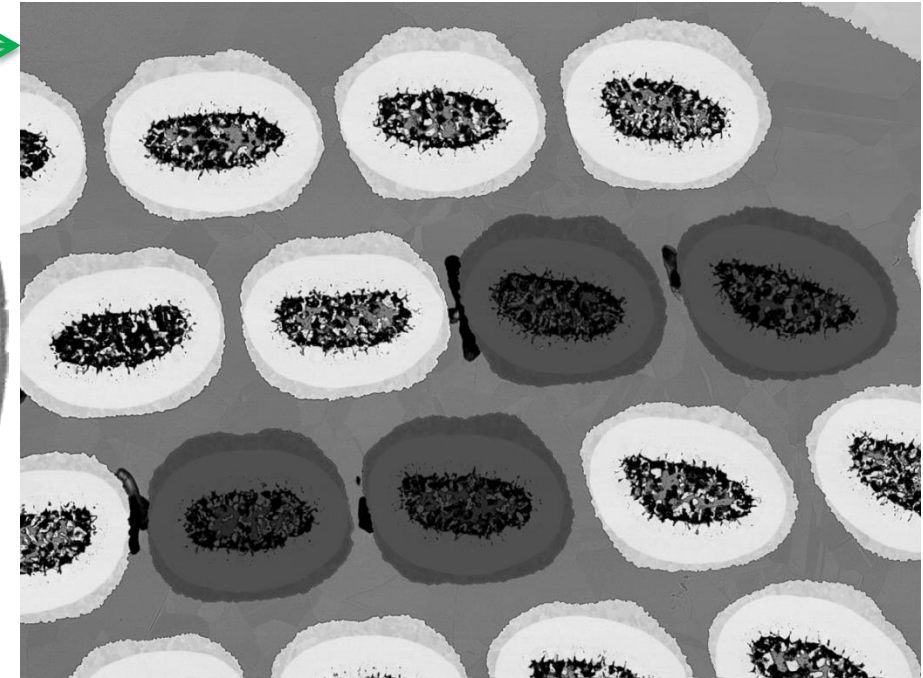
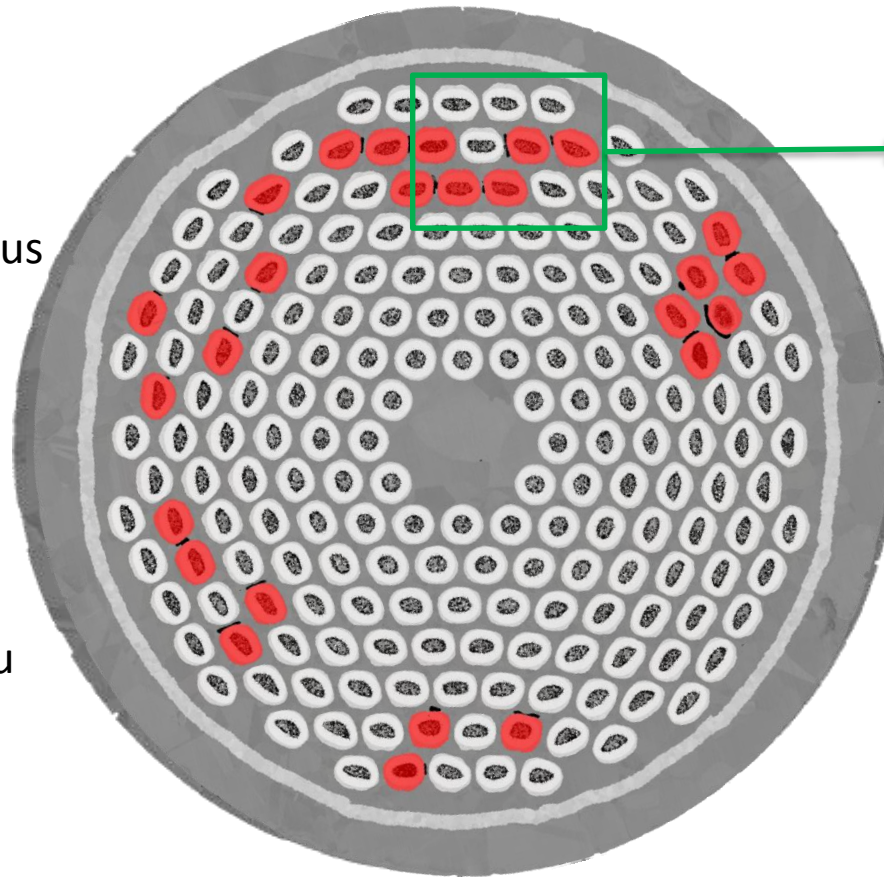
Unbreached:
fully continuous
barrier



Breached:
A15 contacts Cu



Breached:
Kirkendall void
-severe Sn leak



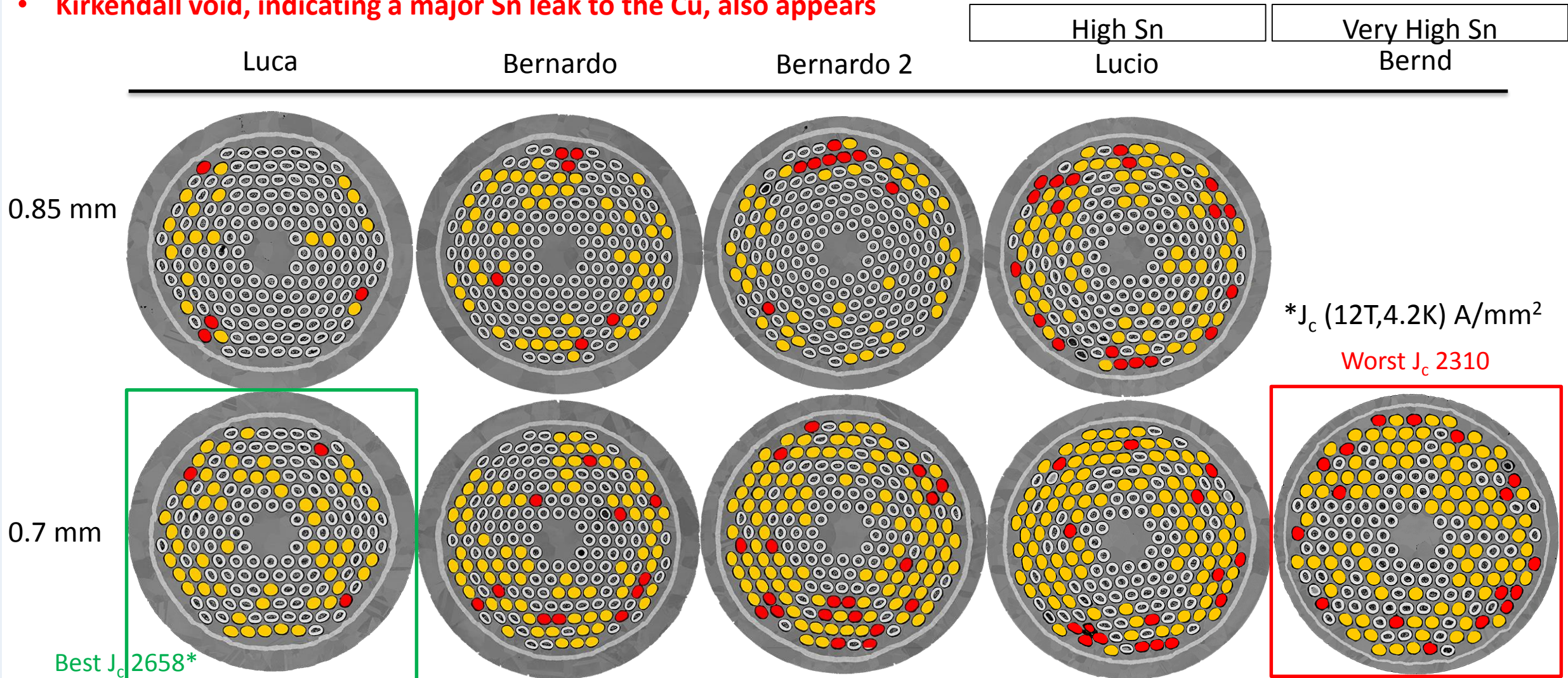
Bernardo 2, 0.7 mm, 27 leaks

- 10% of filaments have SG A15 area reduced by ~5% in a single cross section

	normal area	leaky area	Change	Weighted filaments
Nb	21.5%	23.9%	2.4%	21.7
SG A15	41.9%	36.8%	-5.1%	41.4
LG A15	15.9%	15.9%	0.0%	15.9
Core A15	2.7%	2.2%	-0.5%	
Core Cu	4.6%	8.4%	3.8%	
Core void	13.5%	12.8%	-0.7%	

Wire architecture strongly effects filament integrity

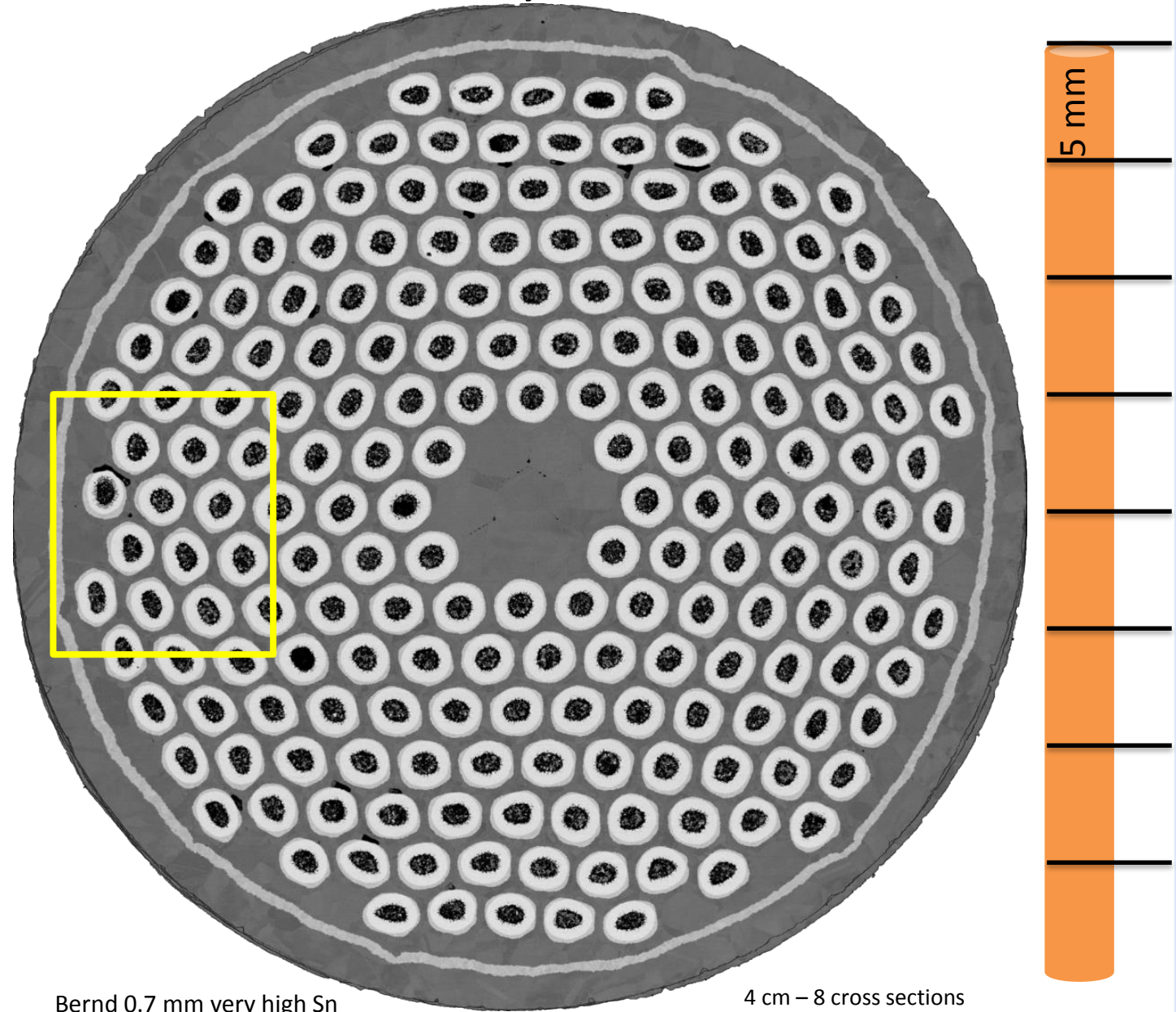
- A15 in contact with Cu
- Kirkendall void, indicating a major Sn leak to the Cu, also appears



Driving questions of the bundle barrier design

- Are leaky filaments compromised for long lengths?
- Do all leaky filaments show a Kirkendall void somewhere along the length of the leak?
 - If so, too many filaments are compromised
 - 4 cm long sample cut into 8 pieces
 - Polished and imaged in SEM
- What are the driving factors causing breached filaments?
- Do inner filaments have higher I_c than outer filaments due to their less frequent barrier breaks?
 - I_c etch experiment

Breached filaments can be seen over many centimeters

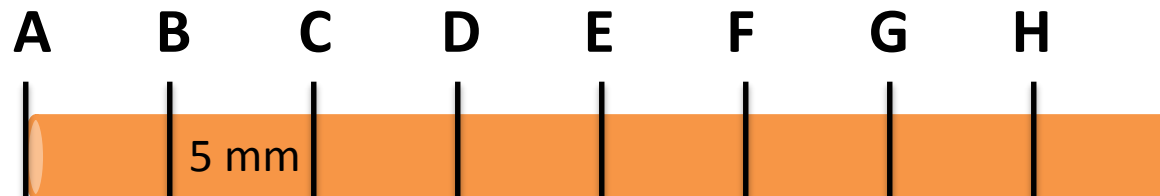
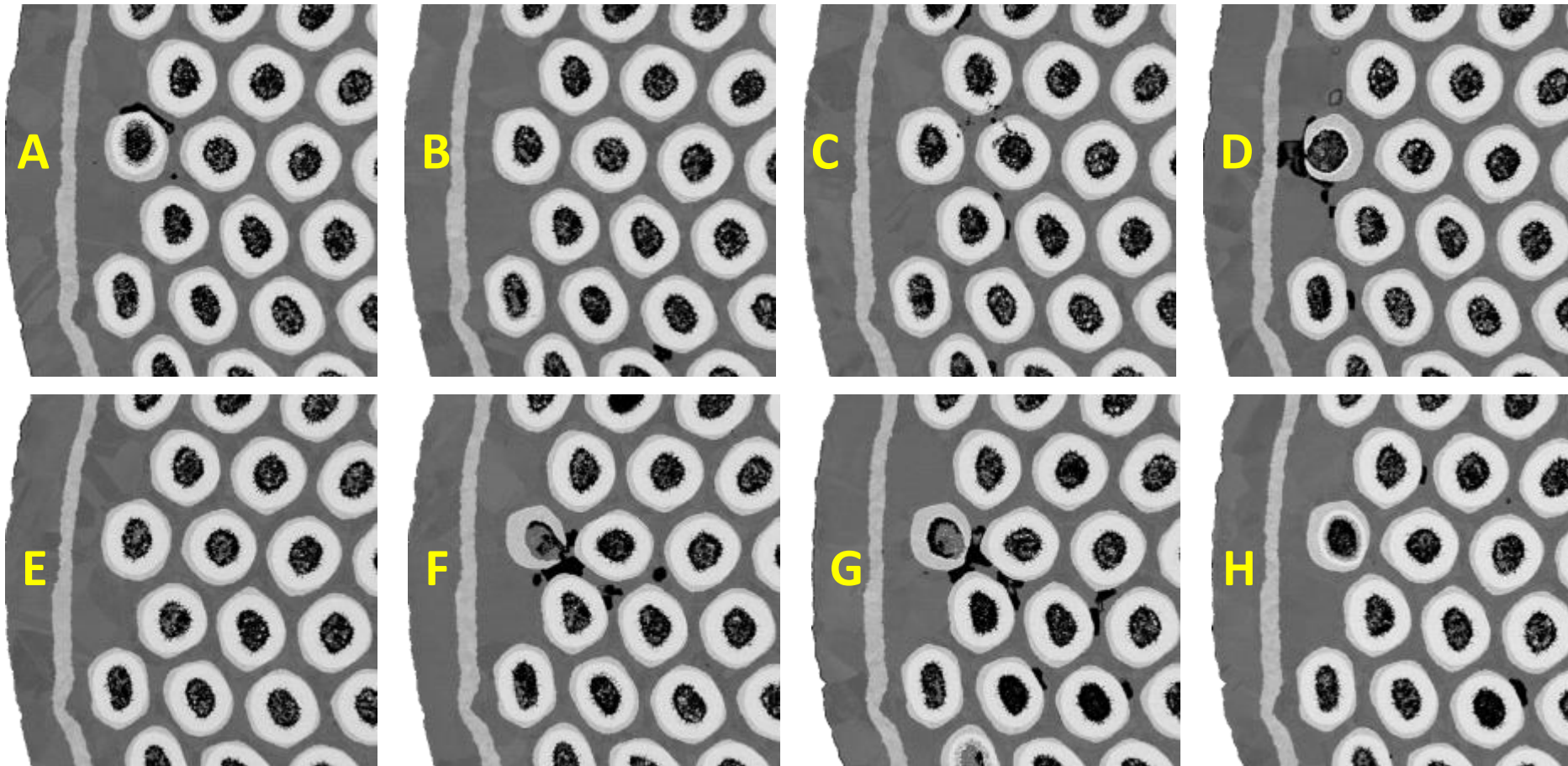


The effect of a breached filament can be much larger than suggested by a single cross-section

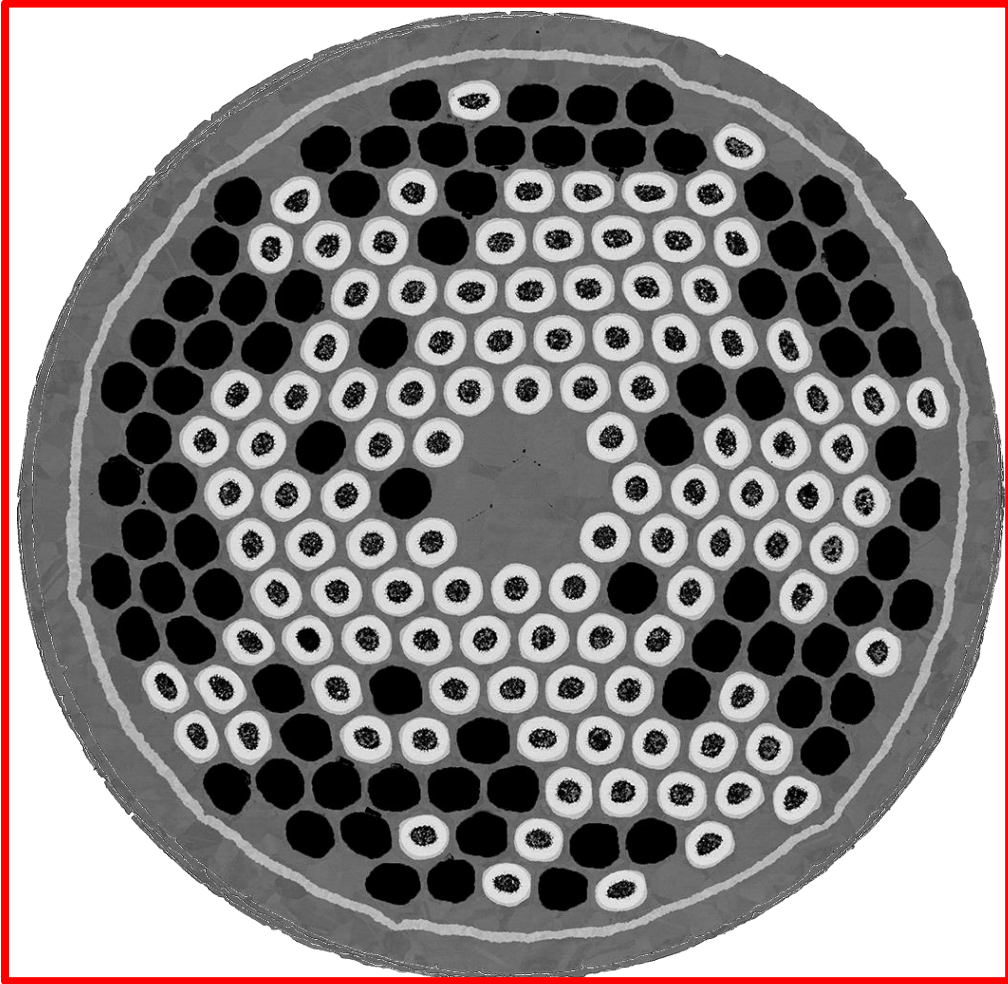
Bernd 0.7 mm very high Sn

4 cm – 8 cross sections

One filament is severely breached in 4/8 cross sections



Leaks are plentiful along the entire 4 cm of wire

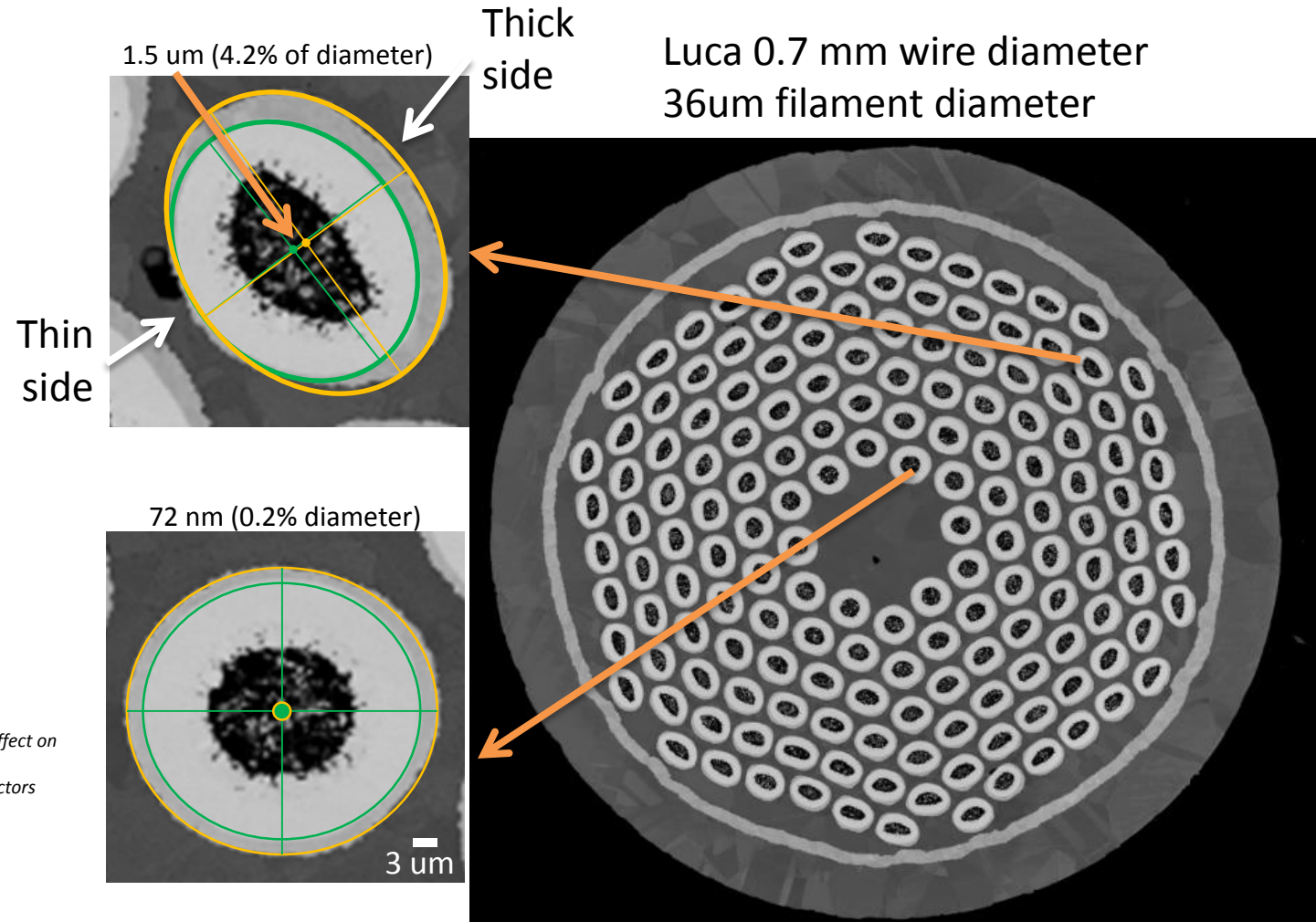


- Bernd 0.7 mm wire, very high Sn
- 15-20 K-void leaks in any given cross-section
- 81 leaked filaments with K-voids over 4 cm, 8 cross sections

- 171/192 breached filaments with A15 in contact with Cu
- Shading corresponds to how many cross-sections show a breach: black = all 8 cross-sections

The leading cause of barrier breach appears to be non-uniform deformation during wire fabrication

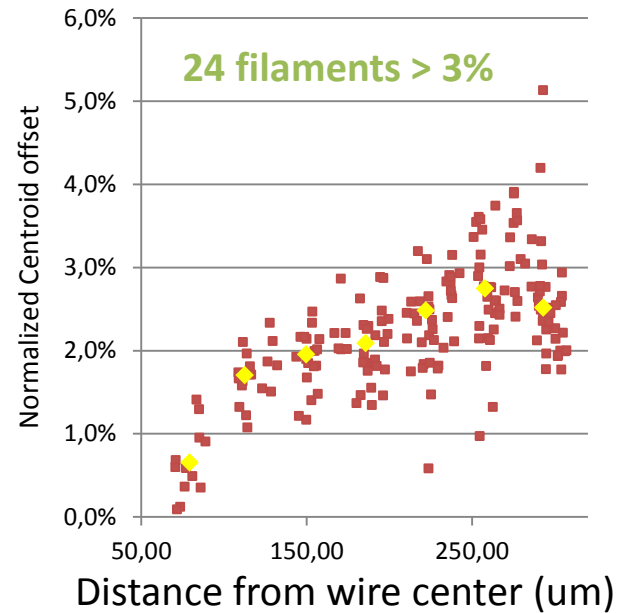
- The centroid offset is the distance between the centroid of the entire filament (orange) and the centroid of the A15 layer (green)
- To most accurately compare between filaments and wires, we normalize each filament's core offset to its own effective diameter, derived from its area.



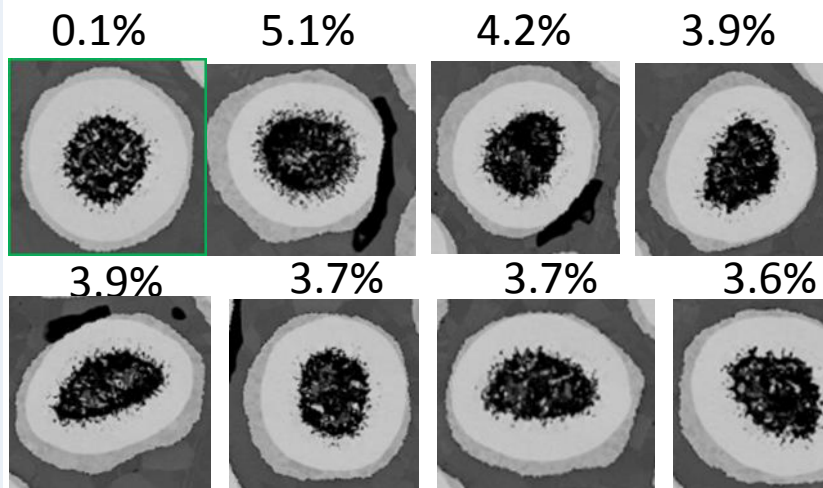
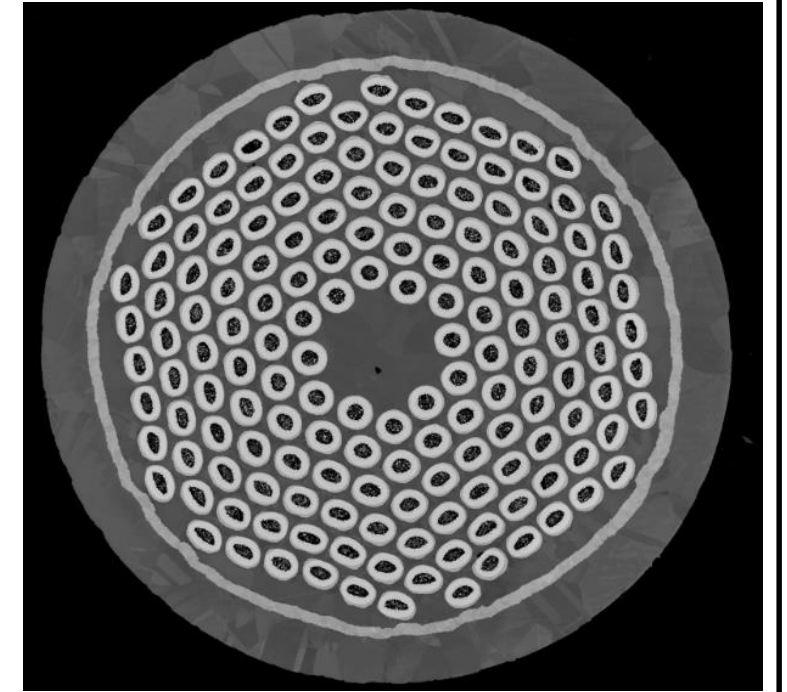
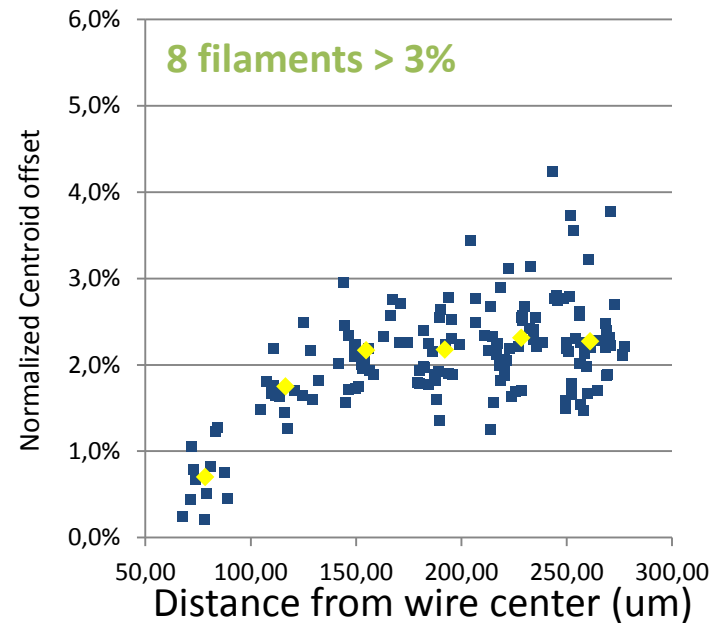
[1] Segal, C.; Tarantini, C.; Lee, P. and Larbalestier, D., *Observations of Local Barrier Breakdown in PIT Wires and its Effect on RRR*, Low Temperature Superconductivity Workshop (LTSW), St. Petersburg, FL, November 4-6 (2013)
[2] Segal, C.; Tarantini, C.; Lee, P.J. and Larbalestier, D.C., *Novel Methods for Improving Nb₃Sn Powder in Tube Conductors for the FCC and Beyond*, Cryogenic Engineering Conference and International Cryogenic Materials Conference, (CEC-ICMC), Madison, WI July 9-12 (2017)
[3] C. Segal et al., "Evaluation of critical current density and residual resistance ratio limits in powder in tube Nb 3 Sn conductors," *Supercond. Sci. Technol.*, vol. 29, no. 8, p. 85003, 2016.

Filaments with large centroid drift are much more likely to leak Sn

Worst J_c 2310* Bernd 0.7 mm

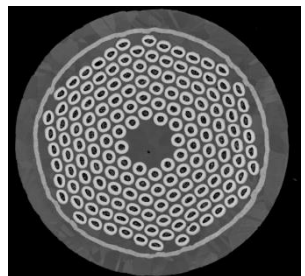
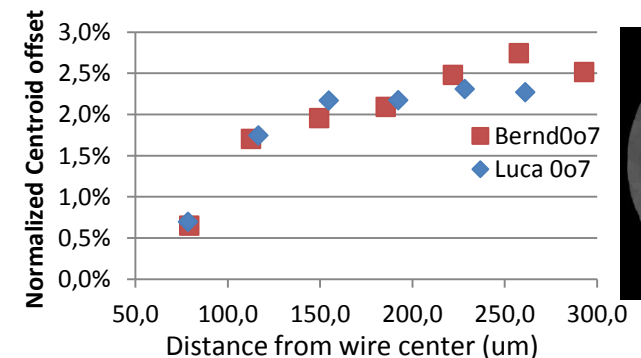


Best J_c 2658* Luca 0.7 mm



*(12T, 4.2K)A/mm²

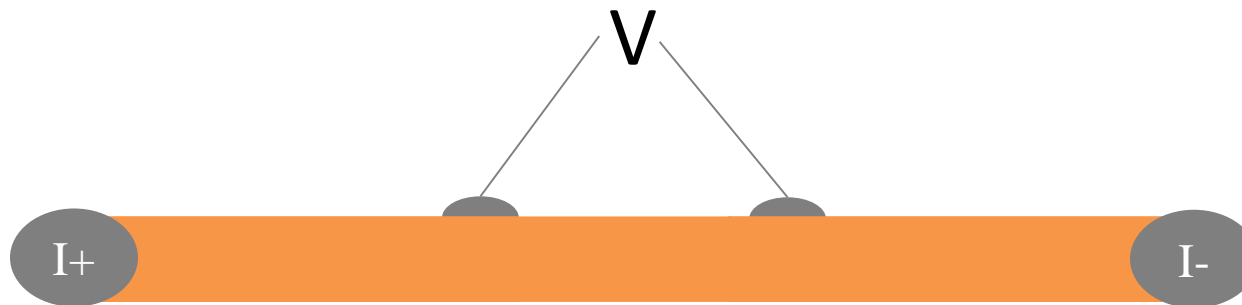
Averaging by ring number



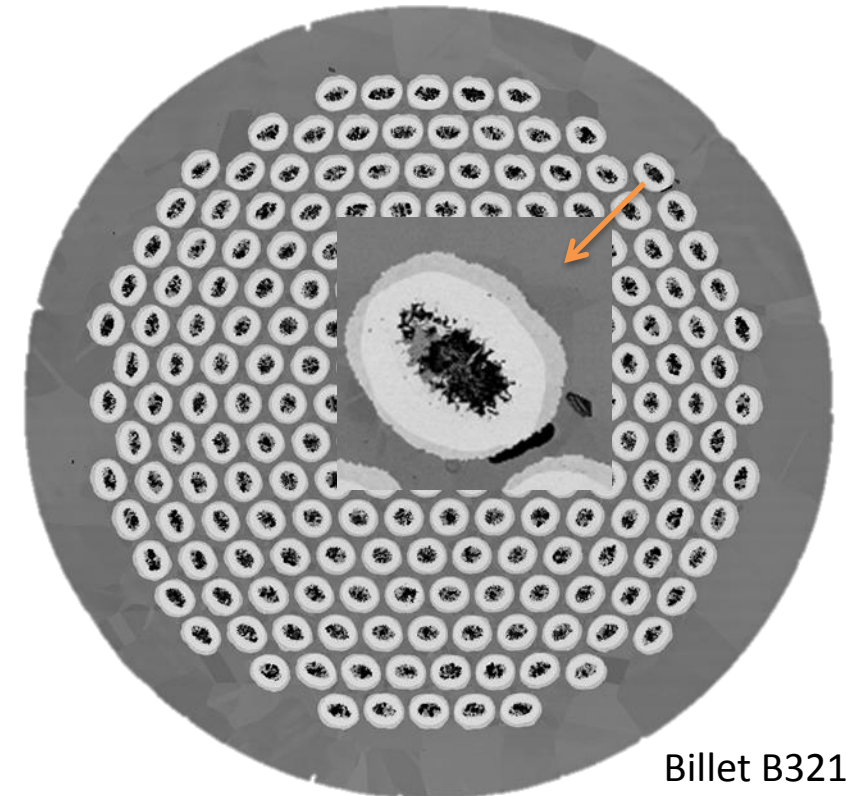
Do inner filaments with less likelihood of leaks have higher J_c than outer filaments?

Procedure and proof of concept

- Measure I_c of wire (1 uV/cm criterion)
- Etch Cu away, break away filaments (<40 um diameter)
 - Measure I_c of remaining inner filaments
- Mount sample in puck for serial imaging
 - Determine which filaments were fully intact for transport measurements

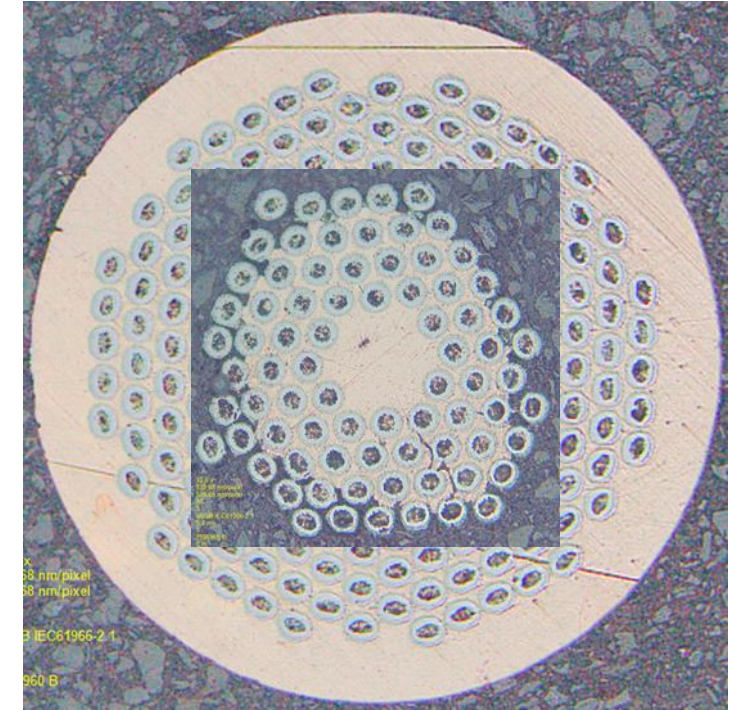
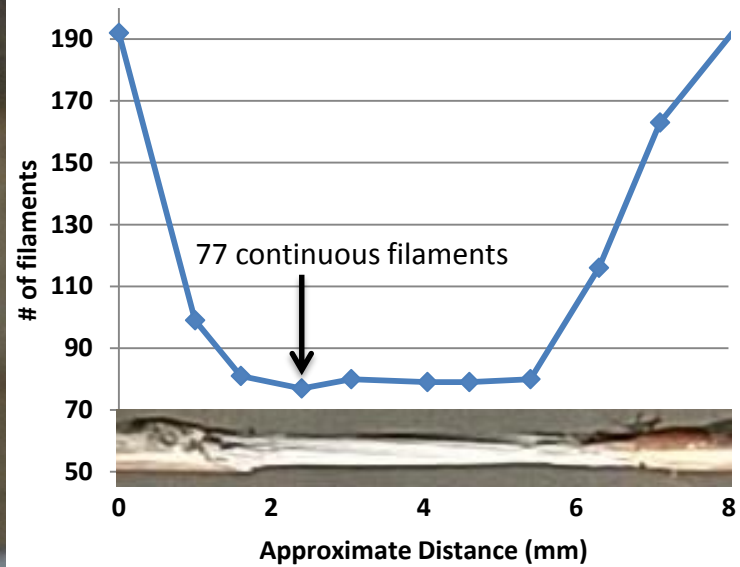
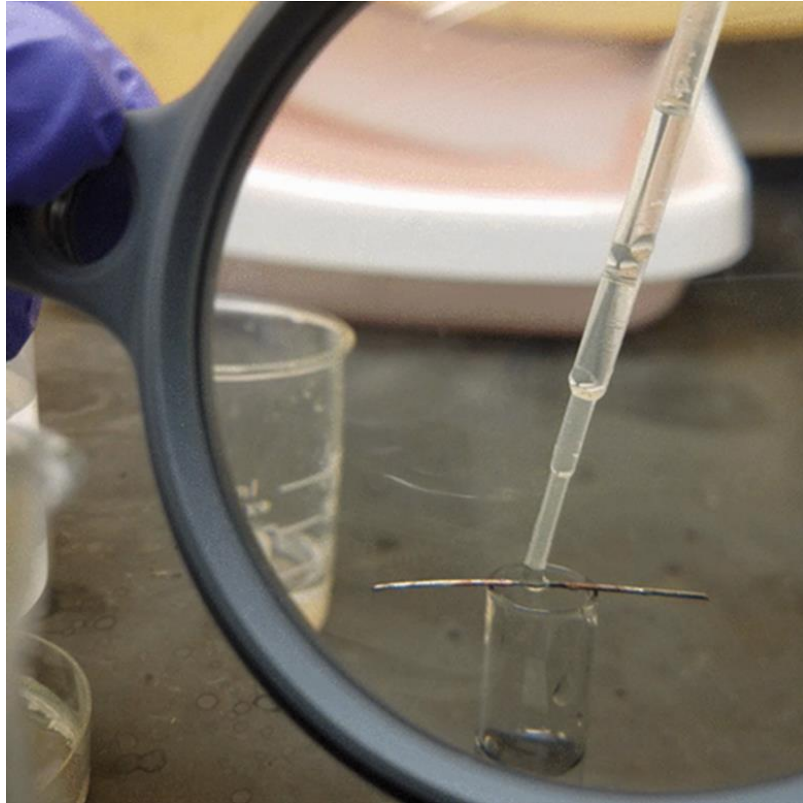


0.78mm wire after full reaction
-no bundle barrier, low Sn, only 1 severe leak with Kirkendall void

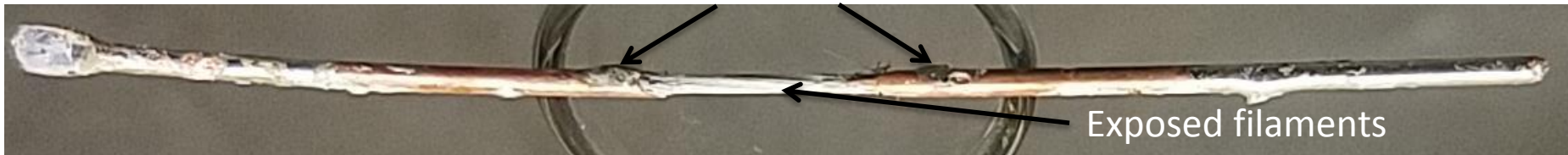


Billet B32184

Etching the wire

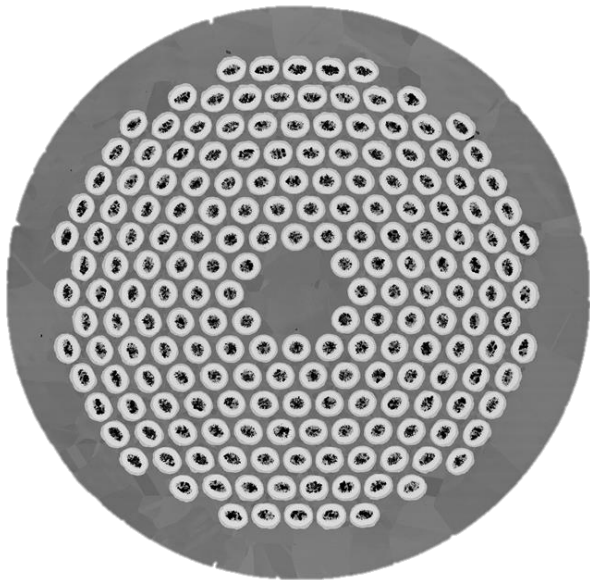
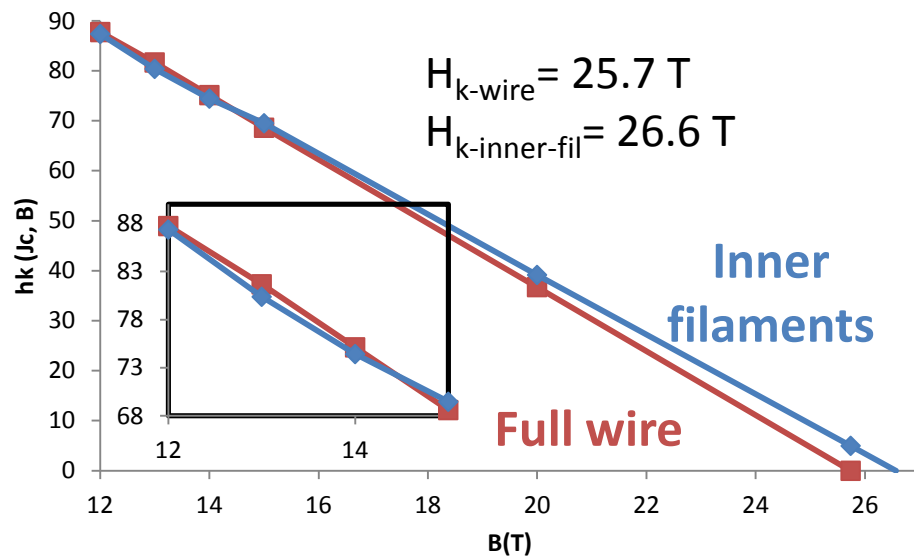


Voltage Taps

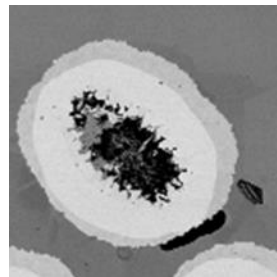


Acid was carefully applied to the area between the voltage contacts

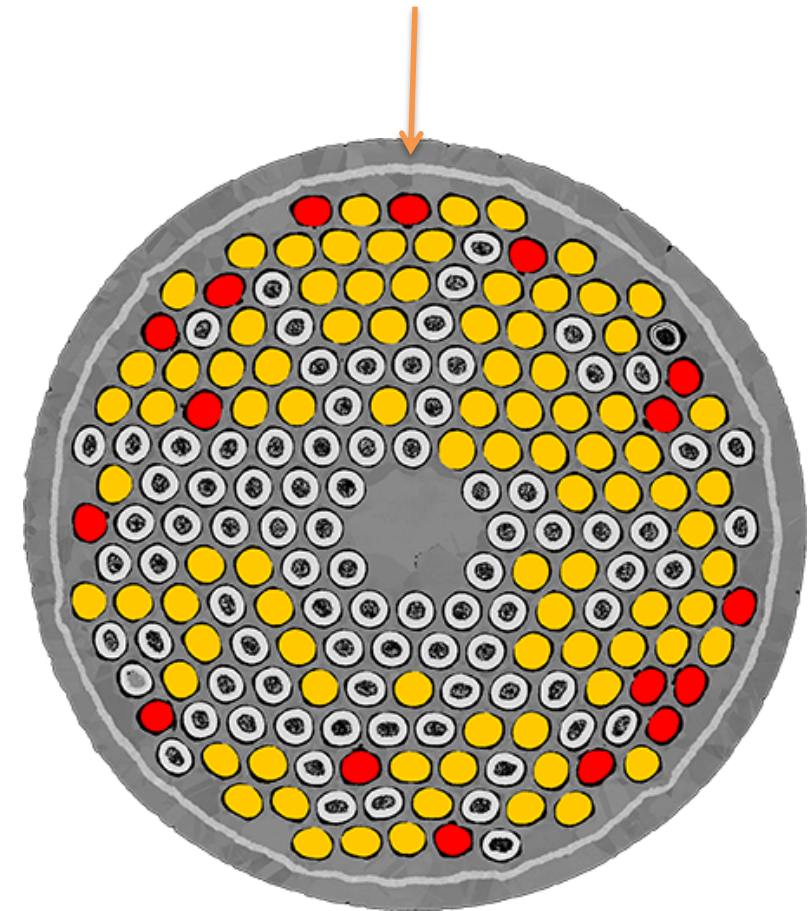
Inner filaments have slightly higher H_k than entire wire



Only a single leak in this cross section.



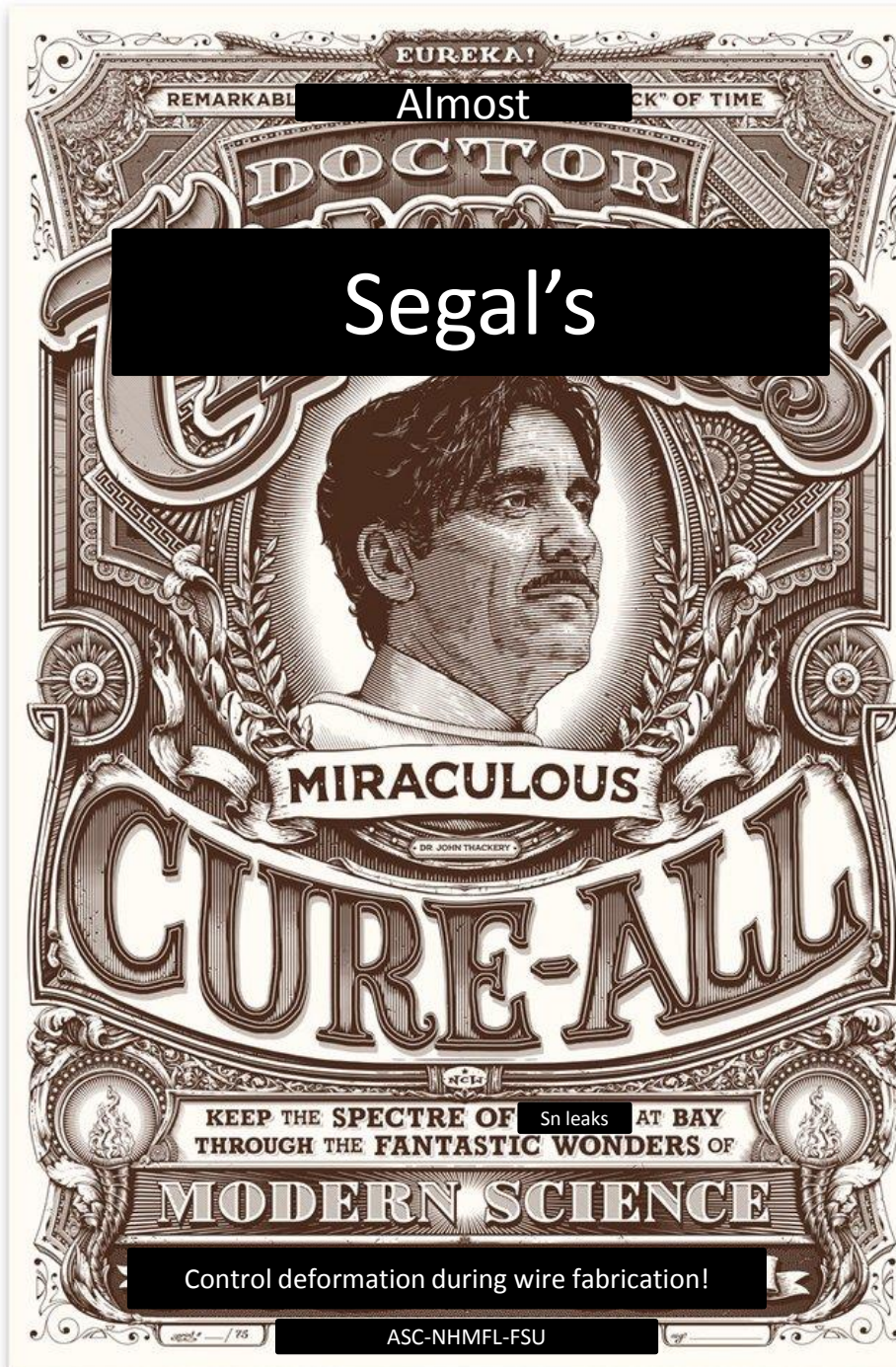
Nb bundle barrier requires HF acid for removal



Conclu

- Non-uniform deformation during
 - J_c : the full A15 volume cannot
 - RRR: Sn leaks out poisons the
 - H_k : Outer filaments have less for FCC
- The biggest contributor to Sn leaki
- A reduction of the non uniform de electrical properties
- My simple suggestion: Use the ver Sn as possible.
 - This means: more reaction to
- Repeat etching experiment to mea

Funding : This work was supported by CERN under grant CERN, and by the National High Magnetic Field Laboratc Experiments on 0.78 mm wires were carried out on Bille collaboration with CERN for the High Luminosity LHC pr



work

ays

r filaments at higher fields needed

e center of its Nb(ta) tube

eturns since it appears to impact all

architecture (Luca) to retain as much

e in the wire, and push H_k higher

Sn leak effects on H_k

f High Energy Physics under award DE-SC0012083, by -1157490), and the State of Florida. rogram (LARP), which is a BNL, FNAL, LBNL, and SLAC on.